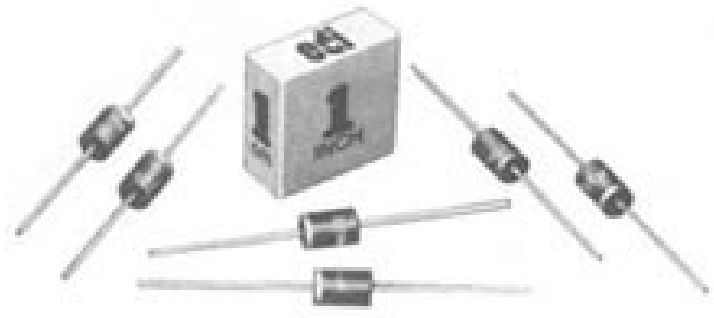




3W 3RW

HIGH VOLTAGE, HIGH CURRENT, FAST RECOVERY SILICON RECTIFIER DIODES

- Up to 250 ns max. recovery
- Small size
- Exceptionally low leakage
- Avalanche characteristics



EDI Type	PRV Voits	REVERSE RECOVERY TIME (Fig.4)
3W2	2,000	Not applicable
3W2.5	2,500	Not applicable
3W3	3,000	Not applicable
3RW2	2,000	250 ns max.
3RW2.5	2,500	250 ns max.
3RW3	3,000	250 ns max.

ELECTRICAL CHARACTERISTICS(at $T_A=25^{\circ}\text{C}$ Unless Otherwise Specified)

ELECTRICAL CHARACTERISTICS	3W	SERIES 3RW	SERIEES
Average Rectified Forward Current @ 50°C , I_o (Fig.1)	2 Amp	1.5 Amp	
Max. Peak Surge Curreent, I_{FSM} (8.3 ms) (Fig.2)	300 Amp	200 Amp	
Max.Forward Voltage Drop @ 2.0 A, V_F	3VDC max.	4VDC max.	
Max. DC Reverse Current @ PRV and 25°C , I_R	5 μA	10 μA	
Max. DC Reverse Current @ PRV and 100°C , I_R	150 μA	200 μA	
Ambient Operating Temperature Range, T_A	-55°C to $+150^{\circ}\text{C}$	-55°C to $+125^{\circ}\text{C}$	
Storage Temperature Range, T_{STG}	-55°C to $+150^{\circ}\text{C}$		

NOTES: It is recommended that a proper heat sink be used on the terminals of this device between the body and soldering point to prevent damage from excess heat. Maximum lead and terminal temperature for soldering, 3/8 inch from case, 5 seconds at 250°C

EDI reserves the right to change these specifications at any time without notice.

3W 3RW

FIG.1
OUTPUT CURRENT vs AMBIENT TEMPERATURE

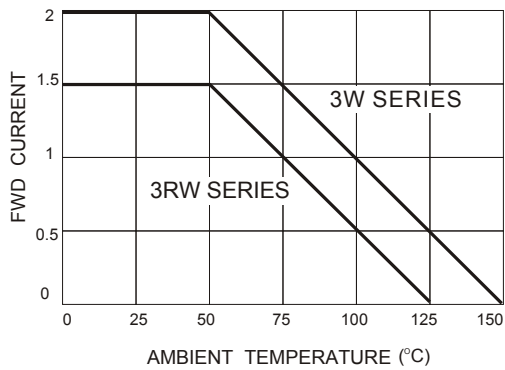


FIG.2
NON-REPETITIVE SURGE CURRENT

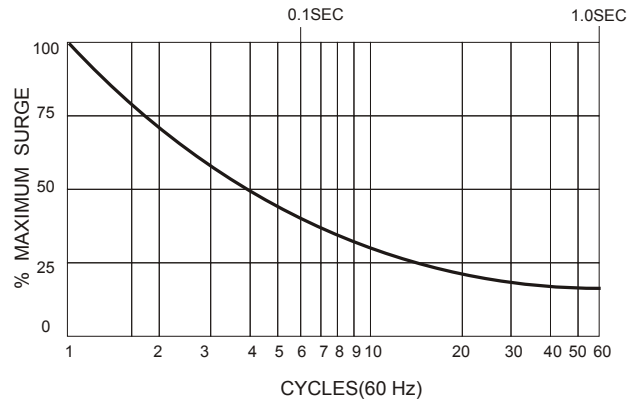
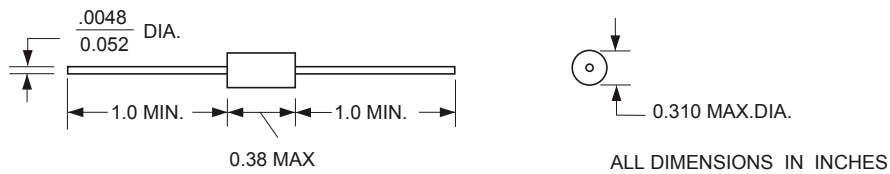


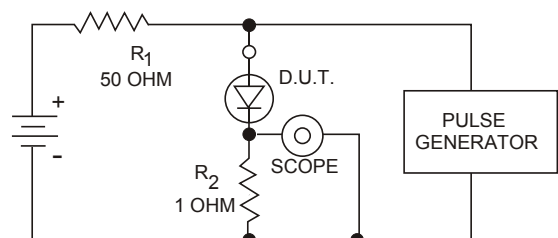
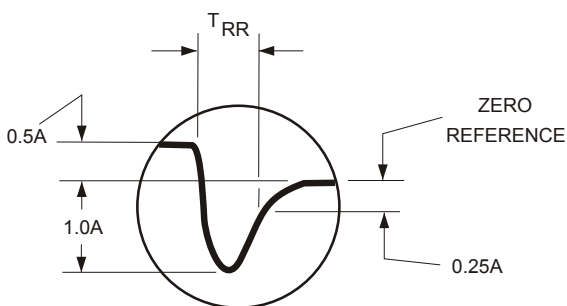
FIG.3



NOTE Maximum lead and terminal temperature for soldering, 3/8 inch form case, 5 seconds at 250 °C

TEST CIRCUIT
FIG.4

TYPICAL REVERSE RECOVERY WAVEFORM



R₁, R₂ NON-INDUCTIVE RESISTORS
PULSE GENERATOR-HEWLETT PACKARD 214A OR EQUIV.
1KC REP.RATE, 10 μ SEC. PULSE WIDTH
ADJUST PULSE AMPLITUDE FOR PEAK I_R